# NPN high voltage **Power transistor**

#### **FEATURES**

- Fast switching
- Excellent thermal stability
- High thermal cycling performance
- Low thermal resistance
- Surface mounting package

## **SYMBOL**

PINNING

PIN

1

2

3

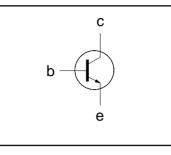
4

base

collector<sup>1</sup>

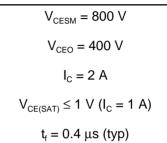
emitter

collector (tab)



DESCRIPTION

# QUICK REFERENCE DATA



tab

2

## **GENERAL DESCRIPTION**

High voltage, high speed glass passivated NPN power transistor in a plastic package.

#### **Applications:-**

Off-line SMPS TV and monitor power supplies Inverters Electronic lighting ballasts

The BUX84S is supplied in the SOT428 (DPAK) surface mounting package.

# LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CESM</sub>	Collector-emitter voltage (peak value)	$V_{BE} = 0 V$	-	800	V
V <sub>CEO</sub>	Collector-emitter voltage	base open circuit	-	400	V
V <sub>EBO</sub> I <sub>C</sub>	Èmitter-base voltage Collector current (DC)	collector open circuit	-	5 2	V A
I <sub>CM</sub>	Collector current (peak value)	$t_p = 2 ms$	-	3	A
I <sub>B</sub>	Base current (DC)		-	0.75	А
I <sub>BM</sub>	Base current (peak value)		-	1	A
-I <sub>BM</sub>	Reverse base current (peak value during turn-off)		-	1	A
P <sub>tot</sub> T <sub>j</sub> , T <sub>stg</sub>	Total power dissipation Operating junction and	$T_{mb} = 25 \ ^{\circ}C$	- - 65	50 150	W °C
	storage temperature				

**Product specification** 

BUX84S

# SO

<sup>1</sup> It is not possible to make connection to pin:2 of the SOT428 package.

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## THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Thermal resistance junction		-	-	2.5	K/W
R <sub>th j-a</sub>	to mounting base Thermal resistance junction to ambient	pcb mounted, FR4 board, minimum footprint	-	50	-	K/W

#### **ELECTRICAL CHARACTERISTICS**

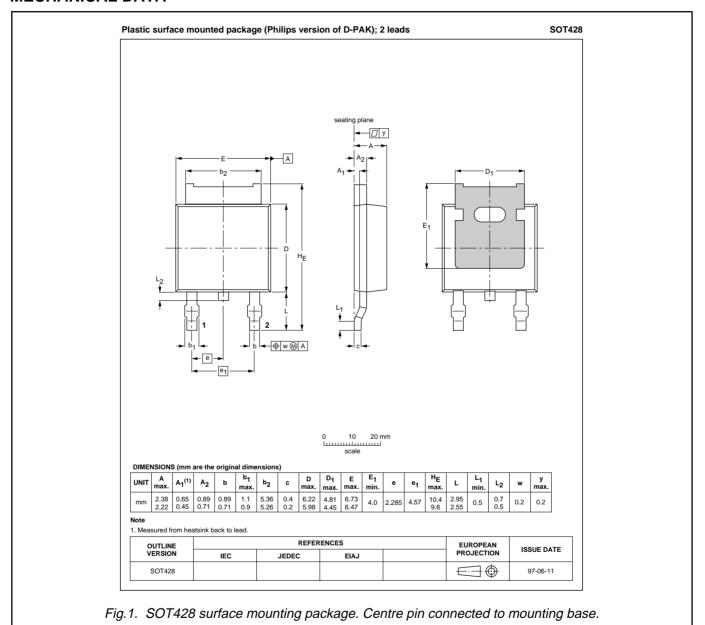
 $T_j$ = 25°C unless otherwise specified For characteristic curves, refer to BUX84 data sheet.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>CEO(sust</sub>	Collector-emitter sustaining voltage	$I_{C} = 100 \text{ mA}; I_{B(OFF)} = 0 \text{ A}; L = 25 \text{ mH}$	400	-	-	V
$V_{CE(SAT)}$	Collector-emitter saturation voltage	$I_{c} = 0.3 \text{ A}; I_{B} = 30 \text{ mA}$ $I_{c} = 1 \text{ A}; I_{B} = 0.2 \text{ A}$	-	-	0.8 1	V V
$V_{BE(SAT)}$	Base-emitter saturation voltage	$I_{\rm C} = 1 \text{ A}; I_{\rm B} = 0.2 \text{ A}$	-	-	1.1	V
I <sub>CES</sub>	Collector-emitter cut-off current	V <sub>CEM</sub> = 800 V; V <sub>BE</sub> = 0 V V <sub>CEM</sub> = 800 V; V <sub>BE</sub> = 0 V; T <sub>i</sub> = 125°C	-	-	200 1.5	μA mA
l <sub>ebo</sub> h <sub>FE</sub>	Emitter-base cut-off current DC current gain	$V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$ $V_{CE} = 5 \text{ V}; \text{ I}_{C} = 5 \text{ mA}$	- 15	-	1 -	mA
		$V_{CE} = 5 \text{ V}; I_{C} = 100 \text{ mA}$	20	50	100	
f <sub>T</sub>	Transition frequency	$V_{ce}$ = 10 V; I <sub>c</sub> = 200 mA; f = 1 MHz	-	20	-	MHz
t <sub>on</sub>	Turn-on time	$I_{C(on)} = 1 \text{ A}; I_{B(on)} = 200 \text{ mA}; I_{B(off)} = -400 \text{ mA}; V_{CC} = 250 \text{ V}$	-	0.2	0.5	μs
t <sub>f</sub>	Fall time	$T_j = 25^{\circ}C$ $T_i = 95^{\circ}C$	-	0.4 -	- 1.4	μs μs
t <sub>s</sub>	Storage time	.,	-	2	3.5	μs

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# MECHANICAL DATA



Notes

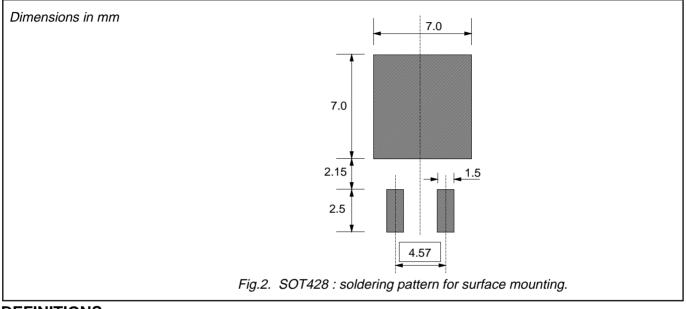
1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.

- 2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
- 3. Epoxy meets UL94 V0 at 1/8".

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## **MOUNTING INSTRUCTIONS**



## DEFINITIONS

Data sheet status				
Objective specification	ective specification This data sheet contains target or goal specifications for product development.			
Preliminary specification	ecification This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values				
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability. <b>Application information</b>				
Where application information is given, it is advisory and does not form part of the specification.				
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## LIFE SUPPORT APPLICATIONS

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